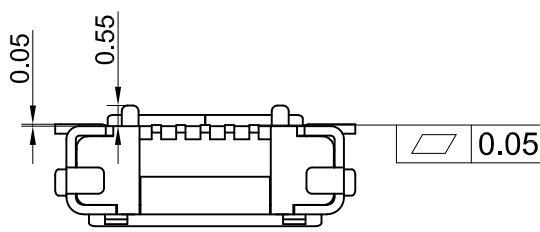
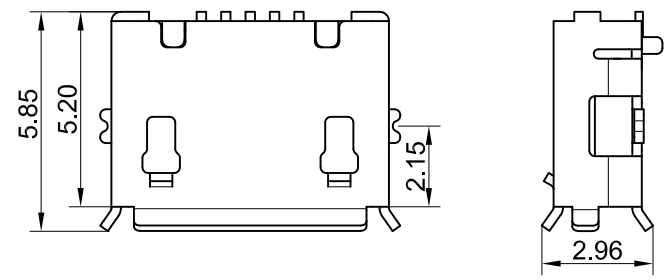


1 2 3 4 5 6 7 8 9

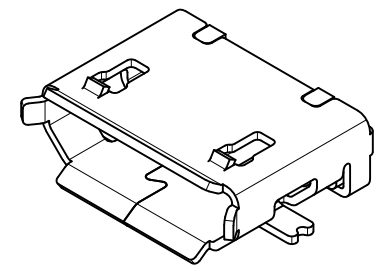
A



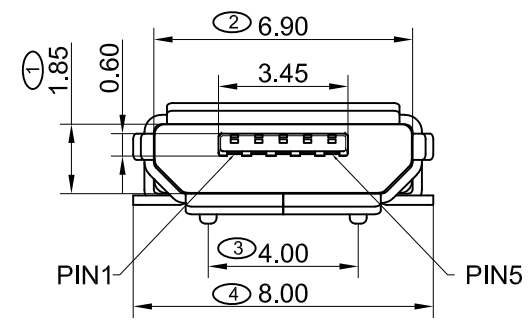
B



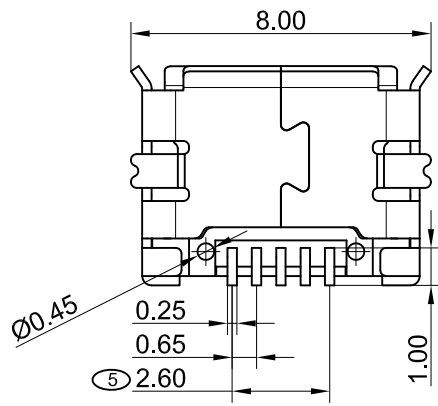
C



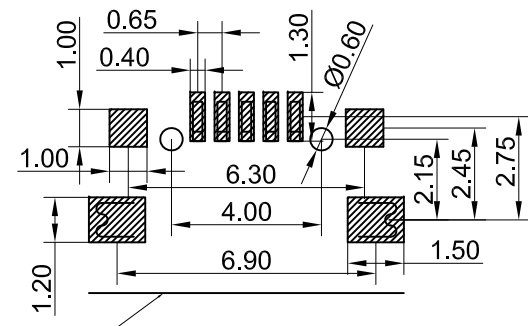
D



E



F



PCB EDGE
RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.05

NOTES:

1. MATERIAL:
 - 1.1 HOUSING: LCP UL94-V0 BLACK
 - 1.2 CONTACT: COPPERY ALLOY T=0.20MM
 - 1.3 SHELL: COPPERY ALLOY T=0.25MM
2. FINISH:
 - 2.1 CONTACT:
1U" MIN, PLATED ON CONTACT AREA
G/F PLATING ON SOLDER TAIL AREA
50~80U" NICKEL UNDERPLATING OVERALL
 - 2.2 SHELL:
80~120U" NICKEL UNDERPLATING OVERALL
3. SPECIFICATION:
 - 3.1 CURRENT RATING: 0.5A (2.3.4 CONTACT) / 1.8A (1.5 CONTACT) MAX.
 - 3.2 VOLTAGE: 30 VAC
 - 3.3 TEMPERATURE RANGE: -20°C ~ 85°C
 - 3.4 CONTACT RESISTANCE: 30 MILLION OHM MAX.
 - 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 250VAC R.M.S
 - 3.6 INSULATION RESISTANCE: 100 MEGOHMS MI

※ SIGN "ⓧ" IS IMPORTANCE DIMENSION

KEM 奇速科技有限公司
Qi-Speed Technology CO., LTD.

產品名稱:
PRODUCT NAME
MICRO USB 板上型 SMT 帶焊盤有柱

單位: mm 比例: 公差: .X ±0.38 .XX ±0.25 .XXX ±0.13 日期: 2018/12/30	繪圖 DRAWING	設計 DESIGNED	審核 CHECKED BY	核准 APPROVAL BY	料號: KMR1-MD05SMB1N-038G PART NUMBER
	JOHNY	JOHNY	LUKE	JAMES	圖號: KMR1-MD05SMB1N-038G-1 DRAWING NO
	版本: REV. 0				

版本	修改事項	修改日期

1 2 3 4 5 6 7 8 9